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(12) **United States Design Patent**
Petsch

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(54) **PAD ARRANGEMENT OF A CIRCUIT MODULE**

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(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (10) Cl.** **02-04**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
USPC D13/182, 123, 133, 110, 184, 199;
257/177, 666, 684, 686, 688, 689, 775;
361/600, 601, 820; 29/825, 829, 830,
29/831, 832; 174/68.1, 250, 253, 254,
174/260, 261, 268; 216/13; 428/901
See application file for complete search history.

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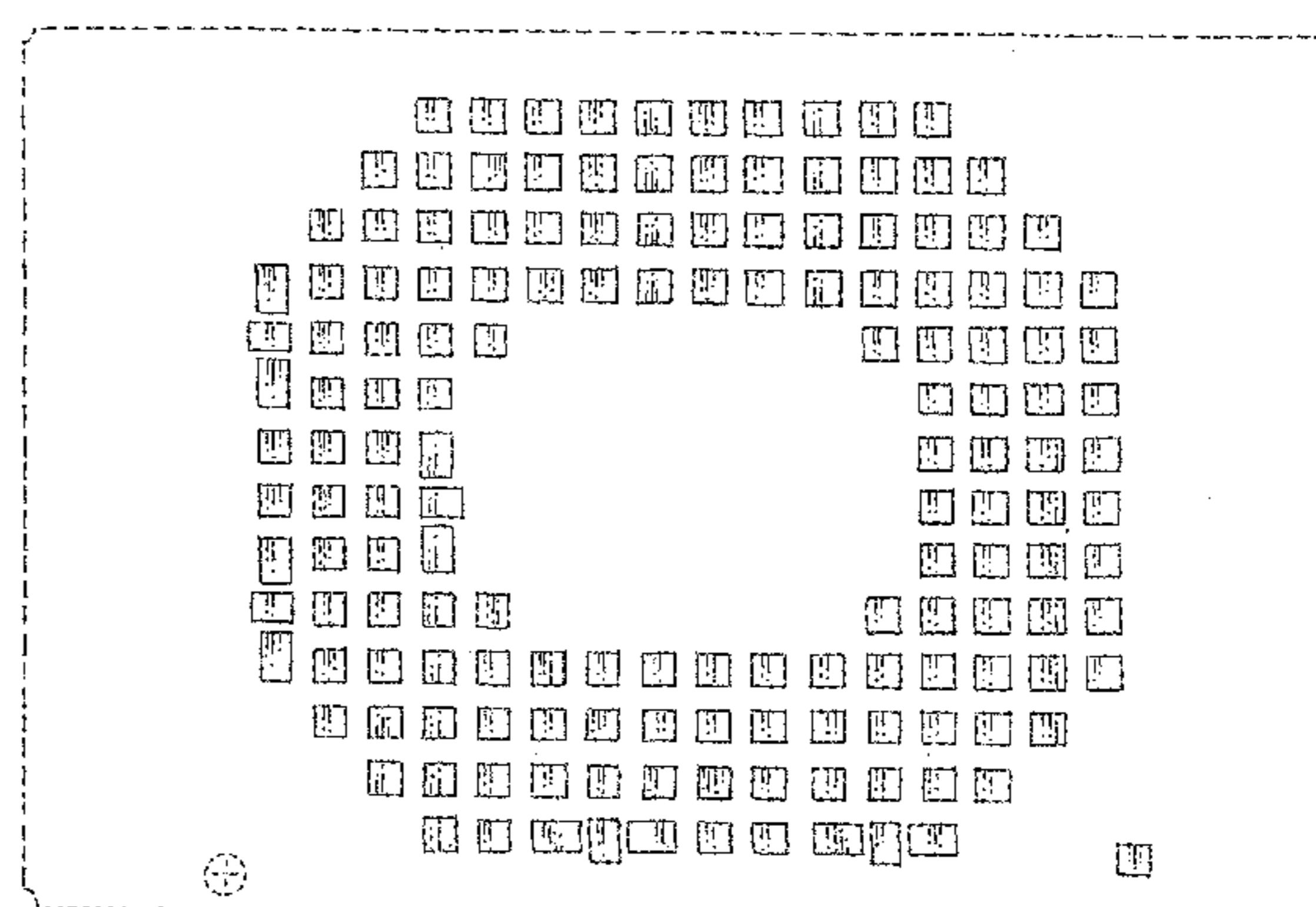
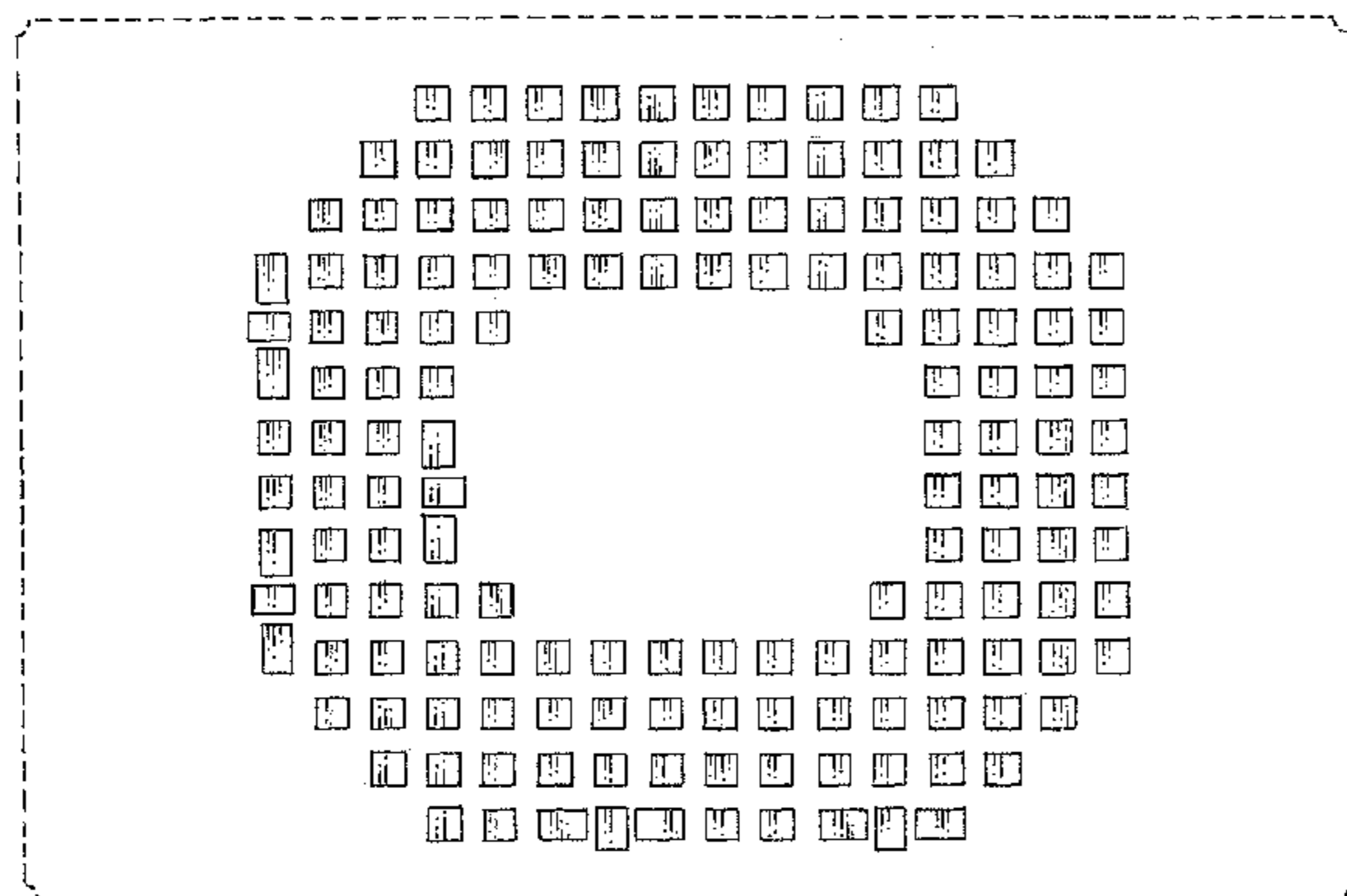
(57) **CLAIM**

The ornamental design for a pad arrangement of a circuit module, as shown and described.

DESCRIPTION

FIG. 1 is a bottom view of a first embodiment of a pad arrangement of a circuit module showing my new design; FIG. 2 is a top view thereof; FIG. 3 is a back view thereof; FIG. 4 is a front view thereof; FIG. 5 is a left side view thereof; FIG. 6 is a right side view thereof; FIG. 7 is a perspective view thereof; and, FIG. 8 is a bottom view of a second embodiment of a pad arrangement of a circuit module showing my new design. All surfaces not shown form no part of the claimed design.

1 Claim, 6 Drawing Sheets



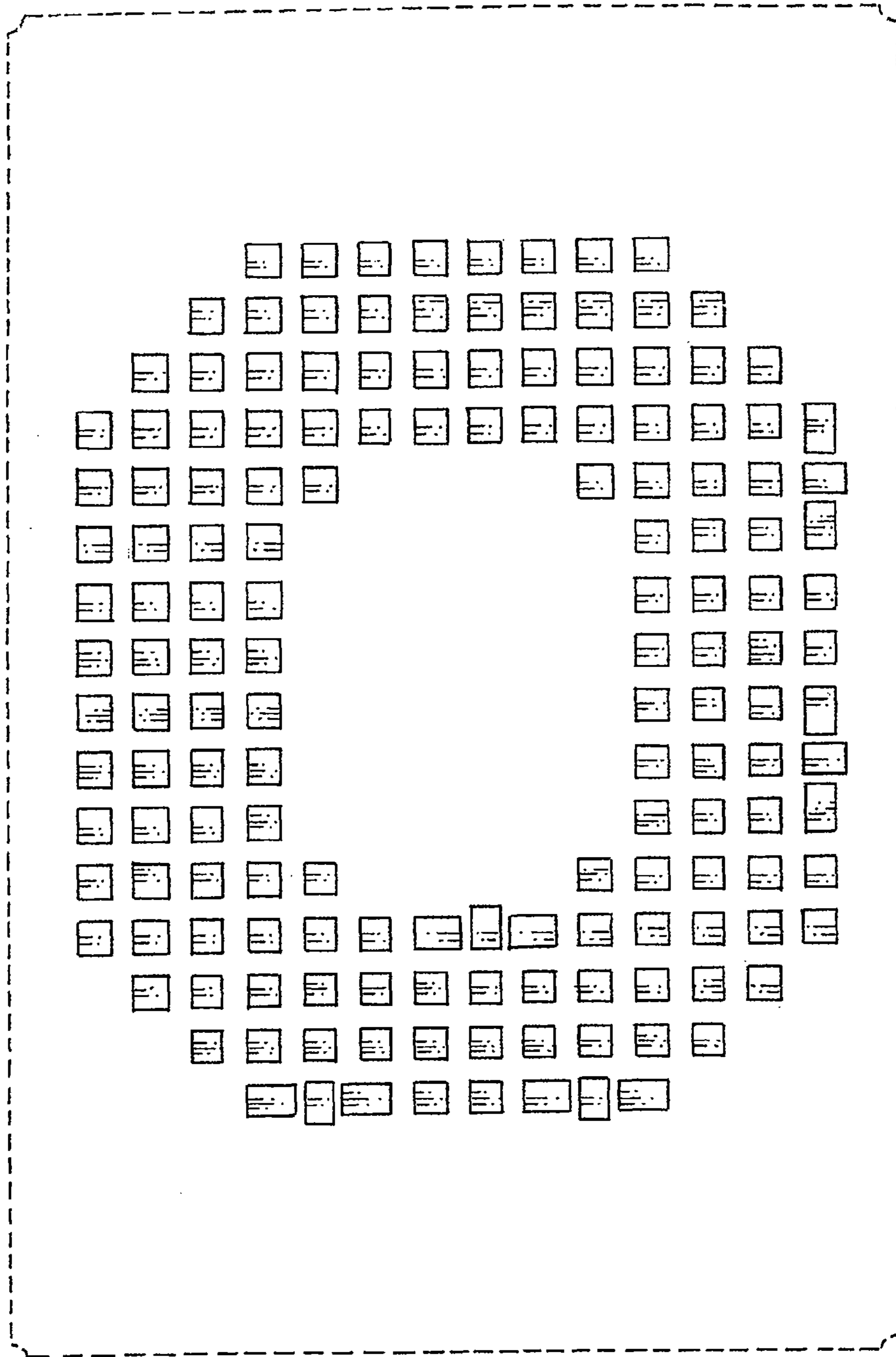


FIG. 1

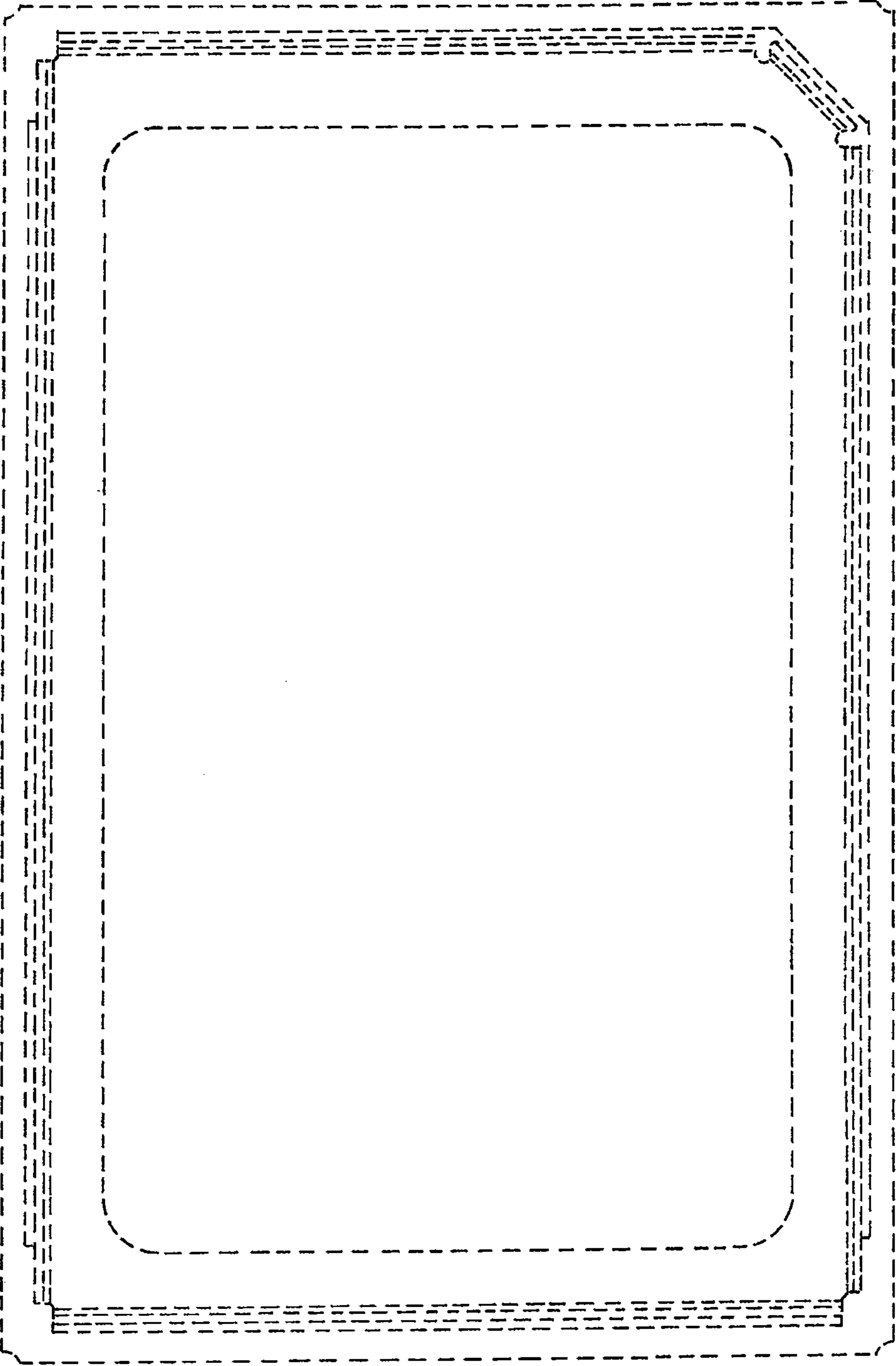


FIG. 2



FIG. 3

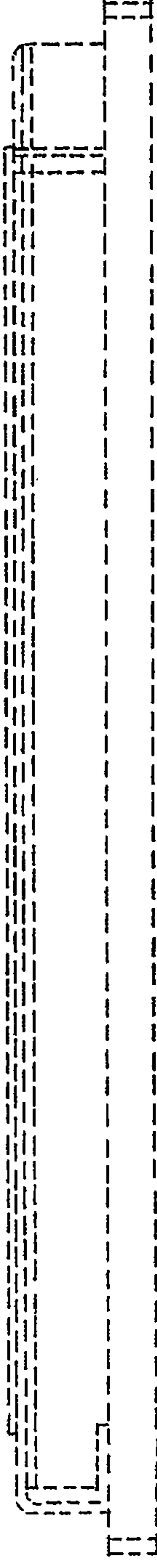


FIG. 4

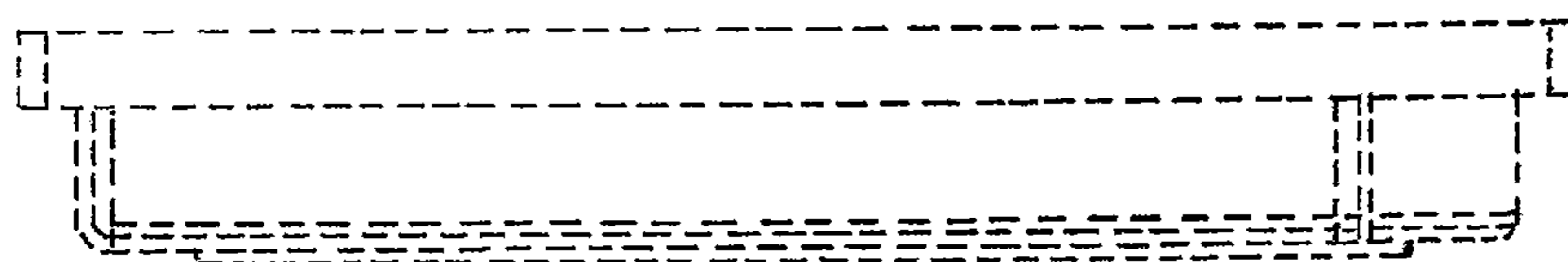


FIG. 6

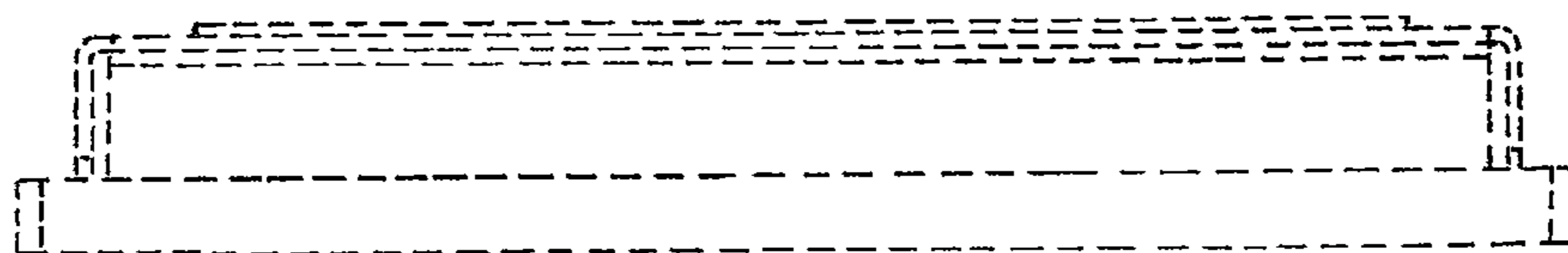


FIG. 5

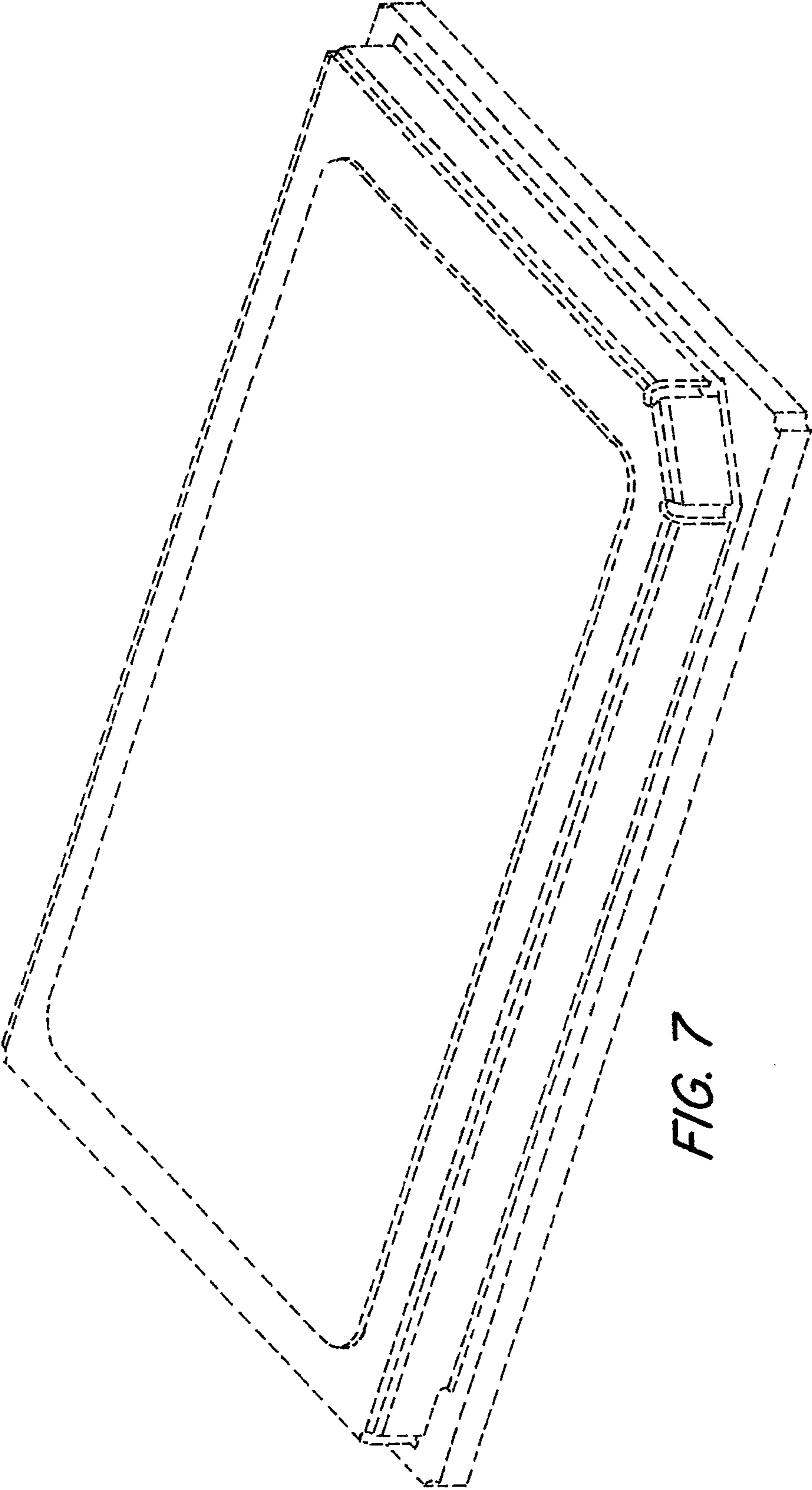


FIG. 7

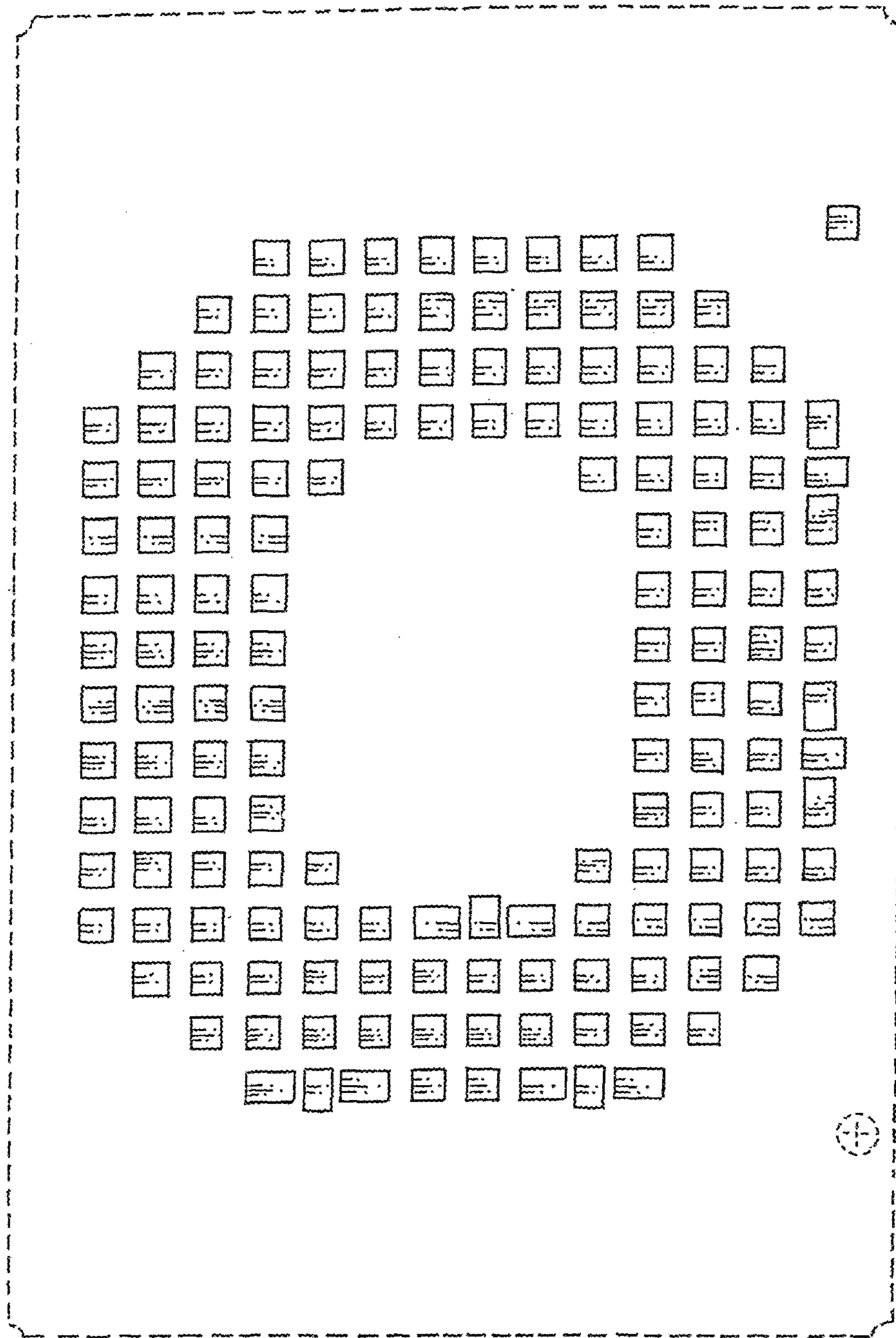


FIG. 8